产品规格书

型号: TL8821CSSC

规格: 12*12*0.8mm 44PIN

版本: V1.0

页数: 24页

Contents

Change History of Revision
1. General Description
2. Features
3. Block Diagram
4. General Specification
4. General Specification
5. Power Supply DC Characteristics
6. Electrical Specifications
7. Bluetooth Specification
8. Pin Definition
9.Size reference
10. SDIO interface Circuit reference pictures
11. Recommended Reflow Profile
12. Packaging Information
13. purchase information

Change History of Revision

	1	Contents of Povision Change Pamerly			
Revisio	Date	Contents of Revision Change	Remark		
1.0	2017-06-23	首次发布产品规格书	2017-06-23		
1.0	2019-02-25	1. 新增加模块图片 2. 修改模块尺寸	2019-02-25		
1.1	2023-01-11	Update the specification format	2023-01-11		

1. General Description

The Realtek RTL8821CS is a highly integrated single-chip that support 1-stream 802.1 lac solutions with Multi-user MIMO (Multiple-Input, Multiple-Output) STA mode with integrated Bluetooth 2.1/4.2 controller, SDIO (SDIO 1.1/2.0/3.0) interface, and HS-UART mixed interface. It combines a WLAN MAC, a 1T1R capable WLAN baseband, and RF in s single chip. The RTL8821CS provides a complete solution for a high-performance integrated wireless and Bluetooth device.

The RTL8821CS baseband implements Multi-user Multiple Input, Multiple Output (MU MIMO) Orthogonal Frequency Division Multiplexing (OFDM) STA mode with one transmit and one receive path (1T1R). Features include one spatial stream transmission, short Guard Interval (GI) of 400ns, spatial spreading, and support for variant channel bandwidth. Moreover, RTL8821CS provides one spatial stream space-time block code (STBC), Transmit Beamforming (TxBF) and Low Density Parity Check (LDPC) to extend the range of transmission. As the recipient, the RTL8821CS also supports explicit sounding packet feedback that helps senders with beamforming capability.

For legacy compatibility, Direct Sequence Spread Spectrum (DSSS), Complementary Code Keying (CCK) and OFDM baseband processing are included to support all IEEE 802.1 lb, 802.1 lg and 802.1 la data rates. Differential phase shift keying modulation schemes, DBPSK and DQPSK with data scrambling capability are available, and CCK provides support for legacy data rates, with long or short preamble. The high speed FFT/IFFT paths, combined with BPSK, QPSK, 16QAM, 64QAM and 256QAM modulation of the individual subcarriers, and rate compatible coding rate of 1/2, 2/3, 3/4, and 5/6, provide up to 433.3Mbps for IEEE 802.1 lac MIMO OFDM.

The RTL8821CS builds in an enhanced signal detector, an adaptive frequency domain equalizer, and a soft-decision Viterbi decoder to alleviate severe multi-path effects and mutual interference in the reception of multiple streams. Robust interference detection and suppression are provided to protect against Bluetooth, cordless phone, and microwave oven interference.

Receive vector diversity for multi-stream application is implemented for efficient utilization of the MIMO channel. Efficient IQ-imbalance, DC offset, phase noise, frequency offset, and timing offset compensations are provided for the radio frequency front-end.

The RTL8821CS supports fast receiver Automatic Gain Control (AGC) with synchronous and asynchronous control loops among antennas, antenna diversity functions, and adaptive transmit power control functions to obtain better performance in the analog portions of the transceiver.

The RTL8821CS MAC supports 802.1 le for multimedia applications, 802.lli and WAPI (Wireless Authentication Privacy Infrastructure) for security, and 802.1 ln/802. llac for enhanced MAC protocol efficiency. Using packet aggregation techniques such as A-MPDU with BA and A-MSDU, protocol efficiency is significantly improved. Power saving mechanisms such as Legacy Power Save, U-APSD, and MIMO power saving reduce the power wasted during idle time, and compensate for the extra power required to transmit MIMO OFDM. The RTL8821CS provides simple legacy, 20MHz/40MHz/80MHz co-existence mechanisms to ensure backward and network compatibility.

The RTL8821CS Bluetooth controller complies with Bluetooth core specification v4.1 and supports dual mode (BR/EDR + Low Energy Controllers). It is compatible with previous versions, including v2.1 + EDR. For BR/EDR, it supports scatternet topology and allows active links in slave mode, and active links in master mode. For Low Energy, it supports multiple states and allows active links in master mode. The links in BR/EDR and LE can be active simultaneously.

2. Features

General

- CMOS MAC, Baseband PHY and RF in a single chip for IEEE 802.1 la/b/g/n/ac compatible WLAN
- Support 802.llac lxl,Wave-2 compliant with MU-MIMO STA
- Complete 802.1 In MIMO solution for 2.4GHz and 5Ghz band

Host Interface

■ Complies with SDIO 1.1/2.0/3.0 for WLAN with clock rate up to 100MHz (SDR50 and DDR50)

Maximum PHY data rate up to 86.7Mbps using 20MHz bandwidth, 200Mbps using 40MHz bandwidth, and 433.3Mbps using 80MHz bandwidth.

Backward compatible with 802.1 la/b/g devices while operating at 802.1 In data rates
Backward compatible with 802.1 la/n devices while operating at 802.1 lac data rates.

G-SPI interface for configurable endian for WLAN Complies with HS-UART with configurable baud rate for Bluetooth

Standards Supported

- IEEE 802.1 la/b/g/n/ac compatible WLAN
- IEEE 802.1 le QoS Enhancement (WMM)
- IEEE 802.lli (WPA, WPA2). Open, shared key, and pair-wise key authentication services
- IEEE 802.1 lh DFS, TPC, Spectrum Measurement

MAC Features

- Frame aggregation for increased MAC efficiency (A-MSDU, A-MPDU)
- Low latency immediate Block Acknowledgement (BA)
- Long NAV for media reservation with CF-End for NAV release
- Multiple BSSID feature allows the RTL8821CS to assume multiple MAC identities when used as a wireless bridge
- Transmit Opportunity (TXOP) Short Inter-Frame Space (SIFS) bursting for higher multimedia bandwidth
- WiFi Direct supports wireless peer to peer applications

Other Features

- Supports Wake-On-WLAN via Magic Packet and Wake-up frame
- Transmit Beamforming

Peripheral Interfaces

- Up to 15 General Purpose Input/Output pins
- Three configurable LED pins (mux with GPIO pins)

PHY Features

- IEEE 802.1 lac OFDM
- IEEE 802.1 In OFDM
- One Transmit and One Receive path
 5MHz /10MHz / 20MHz / 40MHz / 80MHz bandwidth transmission
 Support 2.4Ghz and 5Ghz band

■ IEEE 802.1 lk Radio Resource Measurement WAPI (Wireless Authentication Privacy Infrastructure) certified.
Cisco Compatible Extensions (CCX) for WLAN devices

- PHY-level spoofing to enhance legacy compatibility
- MIMO power saving mechanism Channel management and co-existence
- WiFi NAN (Neighborhood Area Network) support
- WiFi FTM (Fine Time Measurement) supported
- WiFi TDLS (Tunneled Direct Link Setup) Supported

- CCA on secondary through RTS/CTS handshake.
- Support TCP/UDP/IP checksum offload
- Generates 40MHz clock for peripheral chip.
- Single external power source 3.3V only
- Maximum data rate 54Mbps in 802.11 g, 150Mbps in 802.1 In and 433Mbps in 802.1 lac.
- Switch diversity used for DSSS/CCK Support STBC receiving
- Support LDPC transmitting

6/17

- channels
- Short Guard Interval (400ns)
- Sounding packet.
- DSSS with DBPSK and DQPSK, CCK modulation with long and short preamble
- OFDM with BPSK, QPSK, 16QAM, 64QAM and 256QAM modulation. Convolutional Coding Rate: 1/2, 2/3, 3/4, and 5/6

Bluetooth Controller

- Compatible with Bluetooth V2.1+EDR
- Support Bluetooth 4.1 features
- HS-UART interface for Bluetooth data transmission compliant with H4 and H5 specification
- PCM interface for audio data transmission via Bluetooth controller
- Integrated MCU to execute Bluetooth protocol stack
- Supports all packet types in basic rate and enhanced data rate

Bluetooth Transceiver

- Fast AGC control to improve receiving dynamic range
- Supports AFH to dynamically detect channel quality to improve transmission quality
- Integrated internal Class 1, Class 2, and Class 3 PA

Peripheral Interfaces

- General Purpose Input/Output (8 pins)
- 4-wire EEPROM control interface (93C46)
- Three configurable LED pins

Hardware antenna diversity
Fast receiver Automatic Gain Control (AGC)
On-chip ADC and DAC
Build-in both 2.4GHz and 5GHz PA Build-in both 2.4GHz and 5GHz LNA

- Supports SCO/eSCO link (allows one link for PCM interface and three links for HS-UART)
- Supports piconets in a scatternet Supports Secure Simple Pairing Supports Low Power Mode

 (Sniffi^Sniff Sub-rating)
- Enhanced BT/WLAN Coexistence Control to improve transmission quality in different profiles
- Bluetooth 4.0 Dual Mode support: Simultaneous LE and BR/EDR
- Supports multiple Low Energy states
- Supports Enhanced Power Control Supports Bluetooth Low Energy Integrated 32K oscillator for power management
- Flexible CRYSTAL frequency selection(52, 48, 40, 38.4, 27, 26, 25,24,20, 19.2, 17.664, 16, 14.318, 13 and 12MHz)
- Support CRYSTAL or external clock input

3.Block Diagram

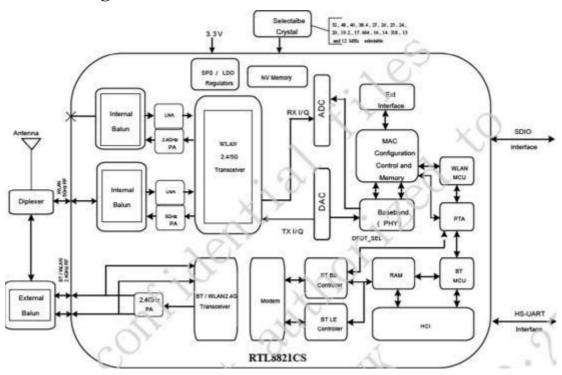


Figure 1. Dual-Band MIMO lxl Solution(llac lxl MAC/BB/RF + PA) and Integrated Bluetooth Controller Solution with Single Antenna ...RTL8821CS

4. General Specification

Model	TL8821CSSC
Product Name	WLAN 1 la/b/g/n/ac SDIO module
Major Chipset	RealtekRTL8821CS
Standard	WIFI: IEEE802.1 la/b/g/n/ac BT:2.1/4.1
Data Transfer Rate	1, 2,5.5,6, ll, 12, 18,22,24,30,36,48,54,60,90, 120 and maximum of 433Mbps
Modulation Method	DSSS, DBPSK, DQPSK, CCK and OFDM (BPSK/QPSK/16QAM/64QAM/256QAM)
Frequency Band	2.4GHz /5 GHz +BT 4.2 v2.1+EDR
OS Support	Linux, Android
Security	64-bit WEP (WEP-40) and 128-bit WEP (WEP-104) encryption with hardware TKIP and CKIP processing

	AES-CCMP hardware processing
	SMS4-WPI (WAPI) hardware processing
Bus Interface	WiFi: SDIO
Bus interface	BT: UART
	WiFi 2.4GHz:
	United States: 11: (Ch. 1-11);
Operating Channel	Europe: 13: (Ch. 1-13);
	Japan: 14: (Ch. 1-14)
	BT 2.4GHz: Ch. 0 ~78
Power Consumption 3.3 V ± 0.2 V I/O supply voltage	
Operating Temperature	0 ~+60° C ambient temperature
Storage Temperature	-20 ~70°C ambient temperature
Humidity 5 to 90 % maximum (non-condensing)	
Dimension	12x12 xl.6mm (LxWxH) ±0.2MM

5.Power Supply DC Characteristics

1) Power Supply Characteristics

Symbol	Parameter	Minimum	Typical	Maximum	Units
VD33	3.3V I/O Supply Voltage	3.0	3.3	3.6	V
VD10	1.05V Core Supply Voltage	0.945	1.05	1.155	V

2) DC Characteristics

Module	Voltage	Current Consumption (linking)
DI CM02D 0021CC V1 0	2.4G	(上网或者看电影时的功耗)
RL-SM02D-8821CS-V1.0	5G	(上网或者看电影时的功耗)

6.Electrical Specifications

1) RF Characteristics for IEEE802.11b (11Mbps mode unless otherwise specified)

Items	Contents			
Specification	IEEE802.11b	IEEE802.11b		
Channel frequency	2412 ~ 2484 M	2412 ~ 2484 MHz		
RX (per<85 dBm@8%)	-85 dBm			
Freq.Error(± 13ppm)	±13 ppm			
TX Characteristics	Min.	Тур.	Max.	Unit
Power Level (±1.5dBm)		16		dBm
EVM (<-18)		-9		dB

2) RF Characteristics for IEEE802.11g (54Mbps mode unless otherwise specified)

Items	Contents	Contents		
Specification	IEEE802.11g	IEEE802.11g		
Channel frequency	2412 ~ 2484 M	2412 ~ 2484 MHz		
RX (per<70 dBm@10%)	-70 dBm	-70 dBm		
Freq.Error(± 13ppm)	±13 ppm	±13 ppm		
TX Characteristics	Min.	Тур.	Max.	Unit
Power Level (±1.5dBm)		15		dBm
EVM (<-25)		-28		dB

3) RF Characteristics for IEEE802.11n (BW20 MCS7)

Items	Contents			
Specification	IEEE802.1 In (IEEE802.1 In (BW20 MCS7)		
Channel frequency	2422 ~ 2462 M	2422 ~ 2462 MHz		
RX (per<65 dBm@10%)	-65 dBm			
Freq.Error(± 13ppm)	±13 ppm			
TX Characteristics	Min.	Тур.	Max.	Unit
Power Level (±1 . 5 dBm)		14		dBm
EVM (<-28)		-28		dB

4) RF Characteristics for IEEE802.11n (BW40 MCS7)

Items	Contents	Contents		
Specification	IEEE802.1 In (IEEE802.1 In (BW40 MCS7)		
Channel frequency	2412 ~ 2484 M	2412 ~ 2484 MHz		
RX (per<65 dBm@10%)	-65 dBm	-65 dBm		
Freq.Error(± 13ppm)	±13 ppm	±13 ppm		
TX Characteristics	Min.	Typ.	Max.	Unit
Power Level (±1.5dBm)		14		dBm
EVM (<-28)		-28		dB

5) RF Characteristics for IEEE802.11ac (BW20 MCS8)

3) Til Onaracichistics for IEEE002. Trac (BW20 MO00)				
Items	Contents	Contents		
Specification	IEEE802.1 lac	IEEE802.1 lac (BW20 MCS8)		
Channel frequency	4.9GHz ~6.0C	4.9GHz ~6.0GHz		
RX (per<61 dBm@10%)	-63 dBm	-63 dBm		
Freq.Error(± lOppm)	± lOppm	± lOppm		
TX Characteristics	Min.	Typ.	Max.	Unit
Power Level (±1.5dBm)		11		dBm
EVM (<-28)		-30		dB

6) RF Characteristics for IEEE802.11ac (BW40 MCS7)

Items	Contents

Specification	IEEE802.1 lac	IEEE802.1 lac (BW40 MCS7)			
Channel frequency	4.9GHz ~6.0G	4.9GHz ~6.0GHz			
RX (per<61 dBm@10%)	-5 8 dBm	-5 8 dBm			
Freq.Error(± lOppm)	± lOppm	± lOppm			
TX Characteristics	Min.	Тур.	Max.	Unit	
Power Level (±2 dBm)		12		dBm	
EVM (<-30)		-30		dB	

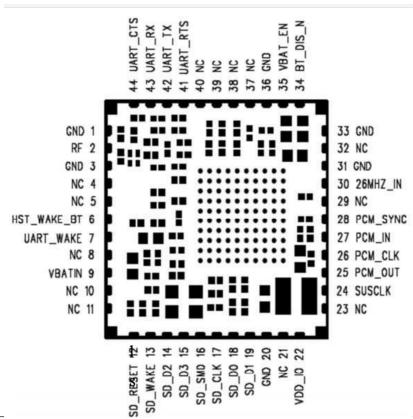
7) RF Characteristics for IEEE802.11ac (BW80 MCS9)

Items	Contents	Contents			
Specification	IEEE802.1 lac	IEEE802.1 lac (BW80 MCS9)			
Channel frequency	4.9GHz ~6.0G	4.9GHz ~6.0GHz			
RX (per<59 dBm@10%)	-51 dBm	-51 dBm			
Freq.Error(± lOppm)	± lOppm	± lOppm			
TX Characteristics	Min.	Тур.	Max.	Unit	
Power Level (±2 dBm)		10		dBm	
EVM (<-32)		-32		dB	

7.Bluetooth Specification

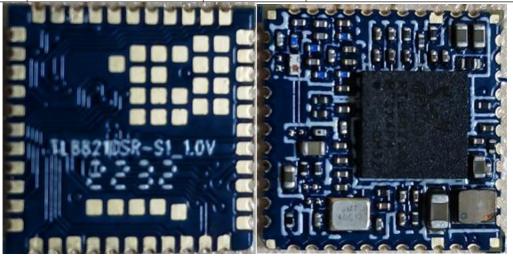
Feature	Description				
General Specification					
Bluetooth Standard Bluetooth V4.1 of 1, 2 and 3 Mbps.			Mbps.		
Host Interface	USB				
Antenna Reference	Small antennas with 0~2 dBi peak gain				
Frequency Band	2.400 GHz ~2483.5 GHz				
Number of Channels	79 channels				
Modulation	FHSS, GFSK, DPSK, DQPSK				
RF Specification					
	Min	Typical	Max		
Output Power (Class 1.5)	2	5	8		
Output Power (Class 2)		2			
Sensitivity @ BER=0.1% for GFSK (1Mbps)		-89			
Sensitivity @ BER=0.01% for n/4-DQPSK (2Mbps)		-85			
Sensitivity @ BER=0.01% for 8DPSK (3Mbps)		-83			
	GFSK(lMbps):-20dBm				
Maximum Input Level	k/4-DQPSK (2Mbps) :-20dBm				
	8DPSK (3N	/lbps) :-20dBm			

8. Pin Definition



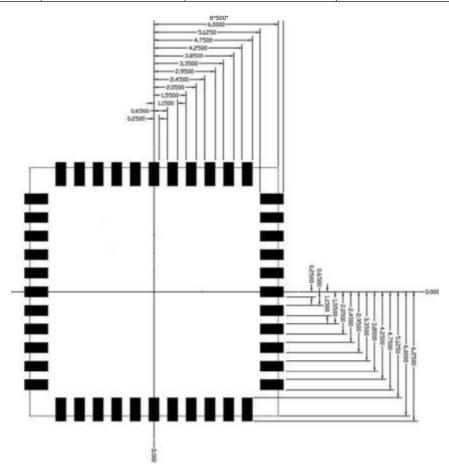
Pin	Functio	n cr	Туре	Description
1	GND	0	_	Ground connections
2	RF		I/O	BTAVLAN 2G RF Differential I/O P
3	GND		_	Ground connections
4~5	NC		_	NC
6	HSTWAKEBT		IO	GPIO13
7	UARTWAKE		IO	GPIO14
8	NC		-	NC
9	VBATIN		p	Battery LDO input, 5.5V-2.8V The power source supplied for this LDO should keep working during system power off. e.g. a battery like power source.
10~11	NC		_	NC
12	SDRESET		IO	GPIO9
13	SDWAKE		IO	GPIO4
14	SDD2		IO	SDIO Data Line2
15	SD D3		IO	SDIO DataLine3
16	SD SMD		IO	SDIO Command Input

1.7	CDCLV	т	CDIO CL. 1 I
17	SDCLK	I	SDIO Clock Input
18	SD D0	Ю	SDIO Data LineO
19	SD D1	IO	SDIO Data Line 1
20	GND	_	Ground connections
21	NC	_	NC
22	VDDIO	P	supply voltage for SDIO IO
23	NC	_	NC
24	SUSCLK	I	Shared with EECS. External 32K or RTC clock input.
25	PCMOUT	IO	GPIO1
26	PCMCLK	IO	GPIO3
27	PCMIN	IO	GPIOO
28	PCMSYNC	IO	GPIO2
29	NC	_	NC
30	26MHZIN	I	26M/40MHz OSC Input Input of 26M/40MHz Crystal Clock Reference
31	GND	_	Ground connections
32	NC	_	NC
33	GND	_	Ground connections
34	BT DIS N	IO	GPIO11
35	VBATEN	I	This pin can externally shutdown the RTL8821CS VBAT LDO (a LDO supports 2.8V ~ 5.5V input and 3.3V output) function when
36	GND		Ground connections
37~40	NC	_	NC
41	UARTRTS	0	High-Speed UART RTS
42	UARTTX	0	High-Speed UART Data Out
43	UARTRX	I	High-Speed UART Data In
44	UARTCTS	I	High-Speed UART CTS



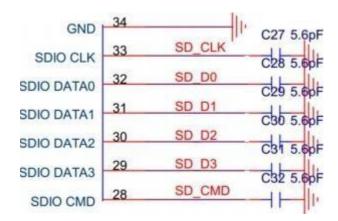
9. Size reference

Dimonsions	Length	Width	Height
Dimensions	12.0	12.0	1.8
(mm)	(Tolerance:±0.2mm)	(Tolerance:±0.2mm)	(Tolerance:±0.1mm)



The PCB tolerances within + / -0.2 or so

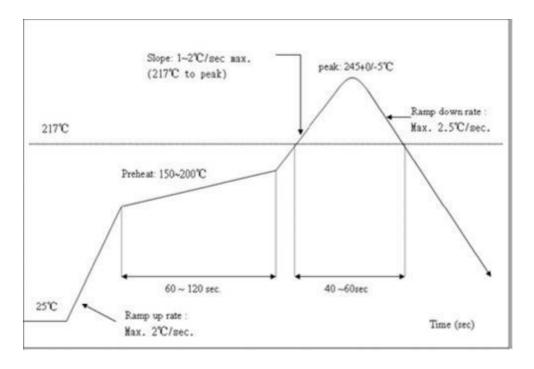
10.SDIO interface Circuit reference pictures



11.Recommended Reflow Profile

Referred to IPC/JEDEC standard.

Peak Temperature : <250°C Number of Times : ≶2 times



12. Packaging information

- 使用真空卷带包装;
- 卷带颜色:蓝色;
- 真空包装内置干燥剂,6色湿度卡;
- 其他未尽事宜按客户要求包装执行;









13. purchase information

TL8821CSSC-X

Z:屏蔽罩